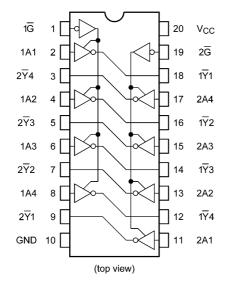
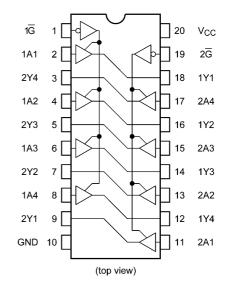
# 5. Pin Assignment

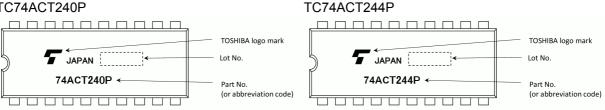
### TC74ACT240P





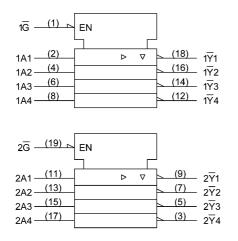
### 6. Marking

#### TC74ACT240P



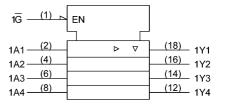
## 7. IEC Logic Symbol

#### TC74ACT240P



### TC74ACT244P

TC74ACT244P



2G <u>(19)</u>	EN		لے		
2A1 (11) 2A2 (13) 2A3 (15) 2A4 (17)		Δ		(9) (7) (5) (3)	· 2Y1 · 2Y2 · 2Y3 · 2Y4

### 8. Truth Table

Input G	Input An	Output Yn (TC74ACT244P)	Output Yn (TC74ACT240P)
L	L	L	Н
L	Н	Н	L
Н	Х	Z	Z

X: Don't care

Z: High impedance

## 9. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V <sub>CC</sub>		-0.5 to 7.0	V
Input voltage	V <sub>IN</sub>		-0.5 to V <sub>CC</sub> + 0.5	V
Output voltage	V <sub>OUT</sub>		-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>		±20	mA
Output diode current	I <sub>ОК</sub>		±50	mA
Output current	I <sub>OUT</sub>		±50	mA
V <sub>CC</sub> /ground current	I <sub>CC</sub>		±200	mA
Power dissipation	PD	(Note 1)	500	mW
Storage temperature	T <sub>stg</sub>		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: 500 mW in the range of  $T_a = -40$  to 65 °C. From  $T_a = 65$  to 85 °C a derating factor of -10 mW/°C shall be applied until 300 mW.

# 10. Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	4.5 to 5.5	V
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	V
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	V
Operating temperature	T <sub>opr</sub>	-40 to 85	°C
Input rise and fall times	dt/dv	0 to 10	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

# **11. Electrical Characteristics**

# 11.1. DC Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
High-level input voltage	V <sub>IH</sub>	—		4.5 to 5.5	2.0	_	—	V
Low-level input voltage	V <sub>IL</sub>	—		4.5 to 5.5	_	—	0.8	V
High-level output voltage	V <sub>OH</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I <sub>OH</sub> = -50 μA	4.5	4.4	4.5	—	V
			I <sub>OH</sub> = -24 mA	4.5	3.94	_	_	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 μA	4.5	_	0.0	0.1	V
			I <sub>OL</sub> = 24 mA	4.5	_	_	0.36	
3-state output OFF-state leakage current	I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = V <sub>CC</sub> or GND		5.5	_	—	±0.5	μΑ
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_		±0.1	μA
Quiescent supply	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	_	8.0	μA
current	I <sub>CCT</sub>	Per input: $V_{IN}$ = 3.4 V Other input: $V_{CC}$ or GND		5.5	_	—	1.35	mA

## 11.2. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C)

Characteristics	Symbol	Test Condition		Note	V <sub>CC</sub> (V)	Min	Max	Unit
High-level input voltage	VIH	—			4.5 to 5.5	2.0	_	V
Low-level input voltage	VIL	—			4.5 to 5.5	_	0.8	V
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA		4.5	4.4		V
			I <sub>OH</sub> = -24 mA		4.5	3.80	_	
			I <sub>OH</sub> = -75 mA	(Note 1)	5.5	3.85	_	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 μA		4.5	_	0.1	V
			I <sub>OL</sub> = 24 mA		4.5	_	0.44	
			I <sub>OL</sub> = 75 mA	(Note 1)	5.5	_	1.65	
3-state output OFF-state leakage current	I <sub>OZ</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or } GND$			5.5	_	±5.0	μΑ
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND			5.5	_	±1.0	μA
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND			5.5	_	80.0	μA
	I <sub>ССТ</sub>	Per input: V <sub>IN</sub> = 3.4 V Other input: V <sub>CC</sub> or GND			5.5	_	1.50	mA

Note 1: This spec indicates the capability of driving 50  $\Omega$  transmission lines.

One output should be tested within a 10 ms maximum duration.

# 11.3. AC Characteristics (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Part Number	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
Propagation delay time		t <sub>PLH</sub> ,t <sub>PHL</sub>		C <sub>L</sub> = 50 pF R <sub>L</sub> = 500 Ω	$5.0\pm0.5$	—	5.7	8.0	ns
3-state output enable time		t <sub>PZL</sub> ,t <sub>PZH</sub>		C <sub>L</sub> = 50 pF R <sub>L</sub> = 500 Ω	$5.0\pm0.5$	—	6.0	9.0	ns
3-state output disable time		t <sub>PLZ</sub> ,t <sub>PHZ</sub>		C <sub>L</sub> = 50 pF R <sub>L</sub> = 500 Ω	$5.0\pm0.5$	_	5.9	8.5	ns
Input capacitance		C <sub>IN</sub>		—		_	5	10	pF
Output capacitance		C <sub>OUT</sub>		—		—	10	—	pF
Power dissipation	TC74ACT240P	C <sub>PD</sub>	(Note 1)	_		_	25	_	pF
capacitance	TC74ACT244P		(Note 1)	—			29		

Note 1: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

 $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/8$  (per bit)

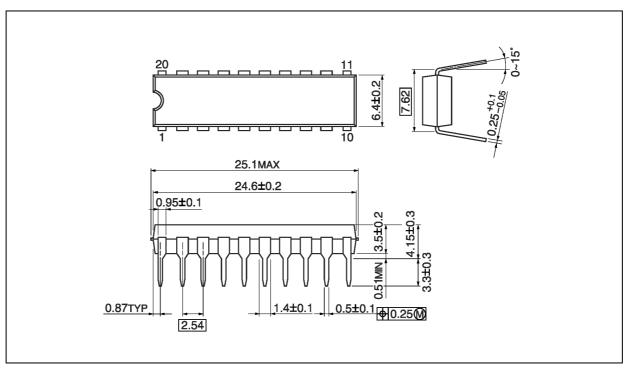
#### 11.4. AC Characteristics (Unless otherwise specified, T<sub>a</sub> = -40 to 85 °C, Input: t<sub>r</sub> = t<sub>f</sub> = 3 ns)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>	C <sub>L</sub> = 50 pF R <sub>L</sub> = 500 Ω	$5.0\pm0.5$	1.0	9.0	ns
3-state output enable time	t <sub>PZL</sub> ,t <sub>PZH</sub>	C <sub>L</sub> = 50 pF R <sub>L</sub> = 500 Ω	$5.0\pm0.5$	1.0	10.5	ns
3-state output disable time	t <sub>PLZ</sub> ,t <sub>PHZ</sub>	C <sub>L</sub> = 50 pF R <sub>L</sub> = 500 Ω	$5.0\pm0.5$	1.0	10.0	ns
Input capacitance	C <sub>IN</sub>	—	-	_	10	pF



# Package Dimensions

Unit: mm



Weight: 1.30 g (typ.)

	Package Name(s)
Nickname: DIP20	

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